



1. General specification 基本事项

1.1 Switch action : Push-on type S. P. S. T

开关种类 : 按键开关

1.2 Switch rating 额定值 : 12 VAC/DC max. 2 VDC min.10mA AC/DC max. 10μA DC min.

1.3 Operation temperature range 使用温度试验范围: - 20 ~ +80℃ 1.4 Storage temperature range 保存温度范围 : - 20 ~ +80℃

1.5 Suggested storage period 贮存期限 : about 6 months 最多六个月

Require the tin part on the switch terminals should keep good after storage guarantee date

要求贮存期后开关端子部分上锡仍然良好

1.6 Appearance and dimensions 外形及尺寸 : See outside drawing page 见外形尺寸图

1.7 Standard condition Unless otherwise specified, the test and measurements shall be

试验、测定状态 carried out as follows:

Ambient temperature 温 度: 20 ± 2 $^{\circ}$ Relative humidity 相对湿度: 45 $^{\circ}$ 85

Air pressure 气压: $86 \sim 106$ kPa $(860 \sim 1060$ mbar)

However, if doubt arises on the decision based on the measured

Values under the above-mentioned conditions, the following conditions shall be employed:

但是在对判定产生疑义时,按下述状态实施:

Ambient temperature 温 度:20±2℃ Relative humidity 相对湿度: 65±5%

Air pressure 气 压: 86 \sim 106kPa(860 \sim 1060mbar)

2. Performance 性能

2.1 Electrical characteristics 电气性能

No.	ltem	Test condition	Performance	
NO.	项目	试 验 条 件	规 格	
2. 1. 1	Contact resistance 接触电阻	Push force: (Operation force) x 2。 则定时的负荷: 操作方向动作力基准值的2 倍。		
2. 1. 2	Insulation resistance 绝缘电阻	. C. 100V(Between terminals)		
2. 1. 3	Withstand voltage 耐电压	A. C100V for 1 min (Between terminals) (端子间)	No. insulation destruction. 无绝缘破坏.	
2. 1. 4	Bouncing 触点抖动	Operation speed : 3~4 times/s 操作速度: 每秒3~4 次 Oscillo scope 示波器 Switch Bouncing Test Circuit 抖动测定回路 D.C.10V 10mA 10KΩ 0scillo Scope 示波器 Switch Bouncing Test Circuit 抖动测定回路 "ON" "OFF"	ON:5ms max 以 下 OFF:5ms max 以下	

2.2 Mechanical Characteristics 机械性能

	Characteristics		
No.	Item 项目	Test condition 试验条件	Performance 规格
2. 2. 1	Operation force 动作力 Travel to closure 动作行程(见 图表)	操作力-行程-图解 Force力 (gf) 120 100 80 operating point 60 40 20 Travel 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7	operating force 操作力 50±10gf Full Travel: 3.0mm+0/-0.5 Pre Travel 预: 1.5mm±0.5
2. 2. 2	Push strength 按压强度	30N(3Kgf)for 15 sec 30N(3Kgf) 15 秒	No damage (Electricaland mechanical) 无异常 (电气、机械性能)
2. 2. 3	Pull strength 推压强度	Break by drawing push plate in the direction of right diagram 抽拨推杆使其破坏的强度.	50N min (5kgf min)
2. 2. 4	Vibration test 耐振性	1) Amplitude 全振幅: 1.5 mm 2) Sweep rate: 10-55-10HZ for 1 minute 扫描速度: 10-55-10HZ 1 分钟 3) Sweep method: Logarithmic frequency sweep rate 扫描方式: 对数频率扫描速度 4) Vibration direction: X, Y, Z(3 directions) 振动方向: X,Y, Z(3 方向) 5) Time: Each direction 2 hours (Total 6 hours) 时间: 每个方向2 个小时(共6 个小时)	No. 2. 1 and 2. 2. 1 to 2. 2. 2 shall be satisfied 满足2. 1 项和2. 2. 1 至 2. 2. 2 项.
2. 2. 5	Soldering heat test 耐焊接热	端子焊接部分浸入焊炉,焊炉温度 260 ± 5 °C,焊接时间 5 ± 1 秒。(焊接时不可于端子施加外力)。 Terminals shall be dipped in the solder bath at 260 ± 5 °C for 5 ± 1 seconds without additional force for terminals.	No damage (electrical and mechanical) 无异常。 (电气、机械特性)
2. 2. 6	Solderbility 可悍性	After sprated flux / 涂上助焊剂后 temperature :260± 5℃ / 温度: 260± 5℃ soldering time :2±0.5 sec/ 焊接时间:2±0.5 秒	90% or more of surface area of the portion immersed in solder shall be covered by new solder / 90% 或更多的浸焊面能被焊锡覆盖.

No.	Item 项目	Test condition 试验条件		Performance 规格	
2. 3. 1	Cold test	1) Temperatu			Contact resistance
2. 0. 1	耐寒性	1) Temperature : - 20±2℃			200m Ω max
		温度: - 20±2℃ 2) Duration of test: 48h			No. 2.1.2 to 2.1.4 and
		持续时间: 48			No. 2. 2. 1 to 2. 2. 2 sha
					Be satisfied
		3) Take off	a drop water		
		去掉水珠		41.	接触电阻 200m Ω以下
			conditions after	test : In	満足2.1.2 到2.1.4 项、
		试验后的放置	余件: 1 小旳		2. 2. 1
		4) =	00 000		到2.2.2 项.
2. 3. 2	Heat test	1) Temperatu			Contact resistance
	耐热性	温度: 60±2			200mΩ max
		2) Duration			No. 2.1.2 to 2.1.4 and
		持续时间: 48			No. 2.2.1 to 2.2.2 shall
			conditions after	test : 1h	Be satisfied
		试验后的放置条件: 1 小时			接触电阻 200m Q以下
					满足2.1.2 到2.1.4 项、2.2
					到
					2. 2. 2 项.
2. 3. 3	Temperature	1) Test cycles :20 cycles			Contact resistance
	cycle	试验周期: 20 个周期			200m Ω max
	温度循环		2) Standard condition after test :1h		No. 2.1.2 to 2.1.4 and
		试验后的放置条件: 1 小时			No. 2.2.1 to 2.2.2 sha
			temperature	duration of	be satisfied
			温度	test	│ 接触电阻 200mΩ以下
				持续时间	満足2.1.2 到2.1.4 项、
		1 cycle	20±5℃	1h	2. 2. 1
		一次	-40 ±2℃	1h	到2. 2. 2 项.
		循环	20 ±5℃	1h	
			60±5℃	1h	
2. 3. 4	Humidity	1) Temperature : 60±2℃		Contact resistance	
	test	温度: 60±2℃			200m Ω max
	耐湿性	2) relative humidity: 90~95%			No. 2.1.2 to 2.1.4 and
		相对温度:90 [~] 95%			No. 2.2.1 to 2.2.2 sha
		3) Duration of test: 96h 持续时间: 96 小时 3) Take off a drop water			Be satisfied
					接触电阻 200m Ω以下
					满足2.1.2 到2.1.4 项、
		去掉水珠	[2. 2. 1
			conditions after	test : 1h	到2.2.2 项.
		试验后的放置			

No.	 Item 项目	Test condition试验条件	Performance
	7,4	,	规格
2. 3. 5	Endurance (switching action) 耐久特性 (开关寿命)	1) D. C. 12V 10mA resistance load D. C 12V 10mA 电阻负荷 2) Operation speed: 1 times / s 动作速度: 2-3 次/ 秒 3) Push force: Maximum value of operation force 按力: 动作力规格值的上限 4) Operation number: 70,000,000cycles 动作次数: 70,000,000次	触点抖动: 10 秒以下
2. 3. 6	盐雾实验 Salt Mist Test	试件在下述实验后测量: 1. 温度: 35±5°C 2. 盐溶液浓度: 5±1%(质量百分比), 3. 试验时间: 4小时, 4. 试验后,将盐沉积物用水冲掉。 The switch shall be checked after following test: 1. Temperature: 35±5°C 2. Salt solution: 5±1%(Solids by mass) 3. Duration: 4 hours, 4. After immersing, salt deposit shall be removed by running water.	Contact resistance $200m\Omega$ max No. 2.1.2 to 2.1.4 and No. 2.2.1 to 2.2.2 shall Be satisfied 接触电阻 $200m\Omega$ 以下 满足2.1.2 到2.1.4 项、2.2.1 到2.2.2 项.
2. 3. 7	Shock 耐冲击性	Measure after test at a condition below 在下列条件下进行测试后的量度 Peak acceleration:80G 冲击加速度:80G Test time-6direction, each 3 times total 18 times 测试次数-6 个方向,各3 次共计18 次。	No. 2.1 and 2.2.1 to 2.2.2 shall be satisfied 第2.1 及2.2.1—2.2.2 都应符合要求



4. Precaution 注意事项

4.1 Soldering condition 浸焊条件

	in Footdoring Condition 及/中水口		
ITEM	CONDITION		
项目	条件		
Preheat temperature	110℃ max (Embilomental temperature of soldering surface of P. W.		
预热温度	E)		
	110℃ 以下(印刷基板焊锡面周围的温度)		
Preheat time 预热时间	60 sec, max 60 秒以内		
Area of flux	1/2 max of P. W. B. thickness		
助焊剂的面积	印刷基板厚度的1/2 以内		
Temperature of solder	260±5℃		
焊锡温度	260±5℃		
Time of immersion	Within 5 sec		
浸焊时间	5 秒以内		
Soldering number	Within 2 times (But should bring down heat of the first soldering)		
浸焊次数	2 次以内(但应把第一次焊锡的温度降下来)		

- 1) After switches were soldered, please be careful not to clean switches with solvent 开关浸焊后,注意不要用溶剂清洗.
- 2) In the case of using soldering iron, soldering conditions shall be 280oC max and 3 sec. max 在使用铬铁的情况下,焊锡温度应在350±10℃ 以下,3 秒以内.
- 3) Right after switches were soldered; please be careful not to load on the knobs of switches. 浸焊后,注意不要在顶部施加负荷.
- 4.2 Note(注意点)
- 1) Please be cautious not to give excessive static load or shock to switches.
- 注意不要施加超负荷的压力或晃动开关.
- 2) Please be careful not to pile up P. W. B. after switches were soldered.
- 开关焊接以后, 印刷基板注意不要叠放.
- 3) Preservation under high temperature and high humidity or corrosive gas should be avoided especially. When you need to preserve for a long period, do not open the carton.

保管时尤其应注意避开高湿高温和有腐蚀性气体的环境. 如需长时间保存, 请不要打开包装箱.

- 4) Panasert RH and RH6 shall be used as the standard insert machine (use N type clinch). 使用标准插入机器PANASERT 和RH6 (使用N 式钉)
- 5) CONTROL HAZARDOUS SUBSTANCE: THE PRODUCT SHOULD BE MEET ROHS SPECIFICATION.

产品应满足 ROHS 环境管理物质管制标准